



Click [here](#) for the 3D model.

Dimensions

| | |
|---|-----------------|
| D | 10mm +/-0.5mm |
| L | 10.2mm +/-0.5mm |
| W | 10.3mm +/-0.2mm |
| H | 10.3mm +/-0.2mm |
| C | 11mm +/-0.2mm |
| P | 4.6mm NOM |
| R | 0.8 - 1.1mm |

Packaging Specifications

| | |
|--------------------|------------|
| Packaging | T&R, 380mm |
| Packaging Quantity | 500 |

General Information

| | |
|----------------|---------------------------------|
| Series | A781 |
| Dielectric | Hybrid Polymer |
| Style | SMD Can |
| Description | Surface Mount, Polymer Aluminum |
| RoHS | Yes |
| Lead | V-Chip |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Halogen Free | Yes |
| Shelf Life | 52 Weeks |
| MSL | 1 |

Specifications

| | |
|-------------------------|--|
| Capacitance | 330 uF |
| Capacitance Tolerance | 20% |
| Voltage DC | 25 VDC, 28.75 VDC (Surge) |
| Temperature Range | -55/+135°C |
| Rated Temperature | 135°C |
| Life | 2000 Hrs |
| Dissipation Factor | 14% 120Hz 20C |
| Resistance | 25 mOhms (100kHz 20C) |
| Ripple Current | 2200 mAmps (100kHz 125C), 2500 mAmps (100kHz 135C), 7000 mAmps (100kHz 105C MAX, With Heat Sink), 4500 mAmps (100kHz 125C MAX, With Heat Sink) |
| Leakage Current | 82.5 uA (2min 20°C) |
| High Temperature Solder | Yes |